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F	R4 DNP R5 DNP		 5V / 10W		2
	R6 DNP R3 DNP T				3
		Title	Texas Instrum Secondary Card for		4
		Size M C Date	Number PMP8363_S 10/01/2012	EC Rev Drawn by B KING	D
	Engineer B KING		IP8363_SEC_REVD.sch	Sheet 1 of 1	
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